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Diodes Incorporated DMC2400UV-7

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Datasheet of DMC2400UV-7 - MOSFET N/P-CH 20V SOT563

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DMC2400UV

COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

| Device | V _{(BR)DSS} | R _{DS(ON)} max | I _D max T _A = +25°C |
|----------|----------------------|--------------------------------|--|
| Q1 | 20V | 0.5Ω @ V _{GS} = 4.5V | 1030mA |
| Q1 20V | 200 | 0.9Ω @ V _{GS} = 1.8V | 740mA |
| Q2 -20V | | 1.0Ω @ V _{GS} = -4.5V | -700mA |
| Q2 | -20V | 2.0Ω @ V _{GS} = -1.8V | -460mA |

Description

This new generation MOSFET has been designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- · Power management functions
- Battery Operated Systems and Solid-State Relays
- Load switch

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage V_{GS(th)} <1V
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected Gate to 2kV HBM
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208³
- Weight: 0.003 grams (approximate)





Top View



SOT563



Bottom View

 $\begin{bmatrix} S_1 \\ \end{bmatrix} \begin{bmatrix} G_1 \\ \end{bmatrix} \begin{bmatrix} D_2 \\ \end{bmatrix}$ Top View
Equivalent Circuit

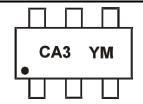
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|--------------|--------|-------------------|
| DMC2400UV-7 | SOT563 | 3000/Tape & Reel |
| DMC2400UV-13 | SOT563 | 10000/Tape & Reel |

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



CA3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

| Year | 201 | 1 | 2012 | | 2013 | 20 | 14 | 2015 | | 2016 | 2 | 2017 |
|-------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code | Υ | | Z | | Α | I | 3 | С | | D | | Е |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

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DMC2400UV

Maximum Ratings - Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Units | | |
|--|----------------------|----------------|------------------|-------------|----|
| Drain-Source Voltage | Drain-Source Voltage | | | | |
| Gate-Source Voltage | | | V _{GSS} | ±12 | V |
| | | I _D | 1030 800 | mA | |
| Continuous Drain Current (Note 6) V_{GS} = 4.5V | | | ID | 1150 900 | mA |
| Continuous Desig Courset (Note CVV - 4.0V | I _D | 740 570 | mA | | |
| Continuous Drain Current (Note 6) V _{GS} = 1.8V | l _D | 870 700 | mA | | |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%) | I _{DM} | 3 | Α | | |
| Maximum Body Diode Continuous Current | Is | 800 | mA | | |

Maximum Ratings - Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Units | | |
|--|------------------|----------------|------------------|--------------|----|
| Drain-Source Voltage | V _{DSS} | -20 | V | | |
| Gate-Source Voltage | | | V _{GSS} | ±8 | V |
| | | I _D | -700 -550 | mA | |
| Continuous Drain Current (Note 6) $V_{GS} = -4.5V$ $t<10s$ T_{μ} | | | I _D | -820 -640 | mA |
| Continuous Drain Correct (Note CVV - 4.0V | I _D | -460 -350 | mA | | |
| Continuous Drain Current (Note 6) V _{GS} = -1.8V | I _D | -550 -420 | mA | | |
| Pulsed Drain Current (10µs pulse, duty cycle = 1%) | I _{DM} | -2 | А | | |
| Maximum Body Diode Continuous Current | Is | -800 | mA | | |

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Units | |
|--|--------------|----------------------------------|-------------|------|
| Total Power Dissipation (Note 5) | P_{D} | 0.45 | W | |
| Thermal Desigtance Junction to Ambient (Note 5) | Steady state | D | 281 | °C/W |
| Thermal Resistance, Junction to Ambient (Note 5) t<10s | | $R_{	hetaJA}$ | 210 | °C/W |
| Total Power Dissipation (Note 6) | | P _D | 1 | W |
| Thormal Decistores Junction to Ambient (Note 6) | Steady state | D | 129 | °C/W |
| Thermal Resistance, Junction to Ambient (Note 6) | | $R_{\theta JA}$ | 97 | °C/W |
| Operating and Storage Temperature Range | | T _{J,} T _{STG} | -55 to +150 | °C |

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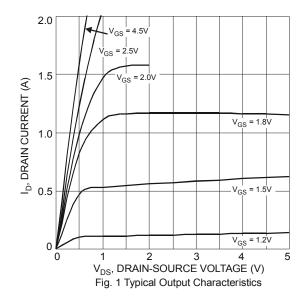
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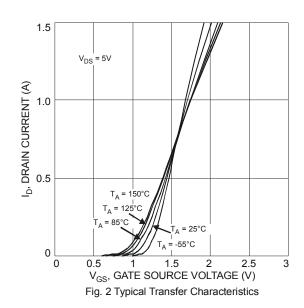
Electrical Characteristics - Q1 N-CHANNEL (@TA = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|---------------------|-----|-------|------|------|--|
| OFF CHARACTERISTICS (Note 7) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 20 | _ | | V | $V_{GS} = 0V$, $I_D = 1mA$ |
| Zero Gate Voltage Drain Current T _J = +25°C | I _{DSS} | _ | _ | 100 | nA | V _{DS} = 20V, V _{GS} = 0V |
| Gate-Source Leakage | 1 | _ | _ | ±1 | μA | V_{GS} = ±5V, V_{DS} = 0V |
| Gale-Source Leakage | I _{GSS} | _ | _ | ±4.0 | μΑ | V_{GS} = ±8V, V_{DS} = 0V |
| ON CHARACTERISTICS (Note 7) | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 0.5 | _ | 0.9 | V | $V_{DS} = V_{GS}$, $I_D = 250\mu A$ |
| | | _ | 0.3 | 0.48 | | $V_{GS} = 5.0V, I_D = 200mA$ |
| | | _ | 0.35 | 0.5 | | $V_{GS} = 4.5V$, $I_D = 200mA$ |
| Static Drain-Source On-Resistance | D | _ | 0.45 | 0.7 | Ω | $V_{GS} = 2.5V, I_D = 200mA$ |
| Static Dialii-Source Off-Resistance | R _{DS(ON)} | _ | 0.55 | 0.9 | | $V_{GS} = 1.8V, I_D = 100mA$ |
| | | _ | 0.65 | 1.5 | | $V_{GS} = 1.5V, I_D = 50mA$ |
| | | _ | 2 | _ | | $V_{GS} = 1.2V, I_D = 1mA$ |
| Forward Transfer Admittance | Y _{fs} | _ | 1.4 | _ | S | $V_{DS} = 3V, I_{D} = 200 \text{mA}$ |
| Diode Forward Voltage | V_{SD} | _ | 0.7 | 1.2 | V | $V_{GS} = 0V, I_{S} = 500mA,$ |
| DYNAMIC CHARACTERISTICS (Note 8) | | | | | | |
| Input Capacitance | C _{iss} | _ | 37.1 | | | 101111 |
| Output Capacitance | Coss | _ | 6.5 | | pF | $V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz |
| Reverse Transfer Capacitance | C _{rss} | _ | 4.8 | _ | | 1 – 1.0WHZ |
| Gate Resistance | R_g | _ | 68 | _ | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, |
| Total Gate Charge | Q_g | _ | 0.5 | _ | | 45)/)/ 40)/ |
| Gate-Source Charge | Q _{gs} | _ | 0.07 | _ | nC | $V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250 \text{mA}$ |
| Gate-Drain Charge | Q_{gd} | _ | 0.1 | _ | | ID - 230IIIA |
| Turn-On Delay Time | t _{D(on)} | _ | 4.06 | _ | | |
| Turn-On Rise Time | t _r | _ | 7.28 | _ | | $V_{DD} = 10V, V_{GS} = 4.5V,$ |
| Turn-Off Delay Time | t _{D(off)} | _ | 13.74 | _ | ns | $R_L = 47\Omega, R_G = 10\Omega,$ $I_D = 200 \text{mA}$ |
| Turn-Off Fall Time | t _f | _ | 10.54 | _ | | ID - 200IIIA |

Notes:

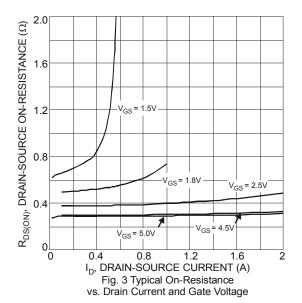
- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.

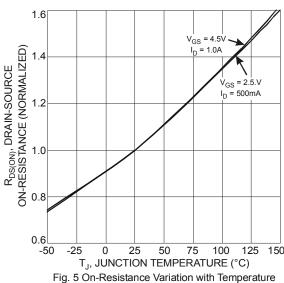






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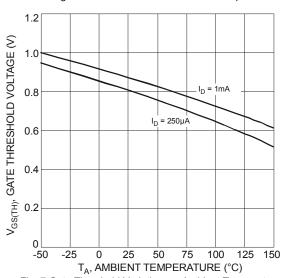


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

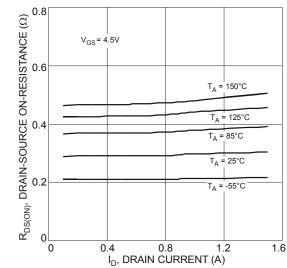


Fig. 4 Typical Drain-Source On-Resistance vs. Drain Current and Temperature

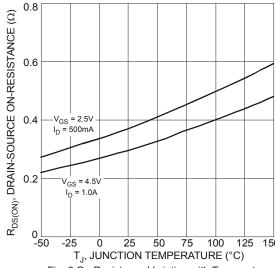


Fig. 6 On-Resistance Variation with Temperature

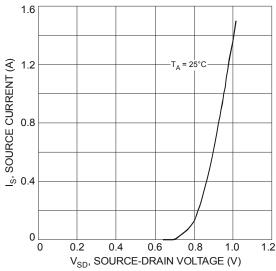
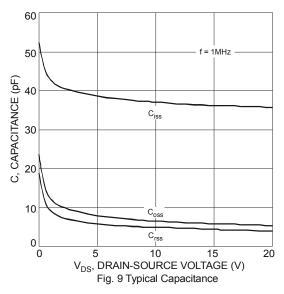
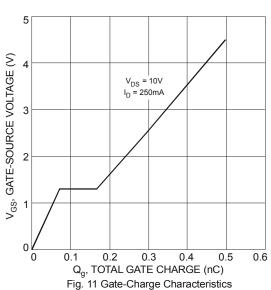


Fig. 8 Diode Forward Voltage vs. Current



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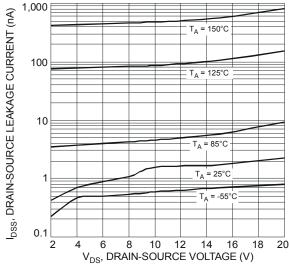
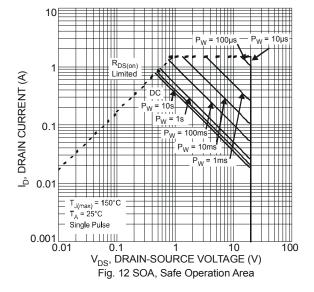


Fig. 10 Typical Drain-Source Leakage Current vs. Drain-Source Voltage





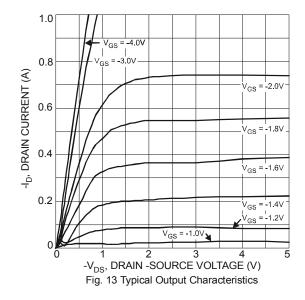
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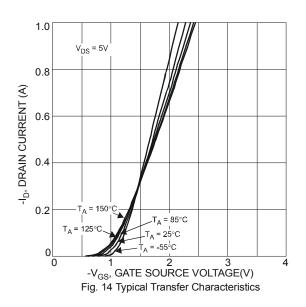
$\textbf{Electrical Characteristics - Q2 P-CHANNEL} \ (@T_A = +25^{\circ}C, \ unless \ otherwise \ specified.)$

| Characteristic | Cumbal | Min | Time | Max | Unit | Test Condition |
|---|----------------------|--------|-------|-------|------|--|
| OFF CHARACTERISTICS (Note 6) | Symbol | IVIIII | Тур | IVIAX | Unit | rest Condition |
| Drain-Source Breakdown Voltage | BV _{DSS} | -20 | l _ | _ | V | $V_{GS} = 0V, I_{D} = -1mA$ |
| Zero Gate Voltage Drain Current T _J = 25°C | I _{DSS} | _ | _ | -100 | nA | V _{DS} = -20V, V _{GS} = 0V |
| | יטטט | | _ | ±1.0 | | $V_{GS} = \pm 5V, V_{DS} = 0V$ |
| Gate-Source Leakage | I _{GSS} | | _ | ±5.0 | μΑ | $V_{GS} = \pm 8V$, $V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 6) | 1 | | | _0.0 | l | 143 250, 155 00 |
| Gate Threshold Voltage | V _{GS(th)} | -0.5 | _ | -1.0 | V | V _{DS} = V _{GS} , I _D = -250μA |
| | | _ | 0.67 | 0.97 | | V _{GS} = -5V, I _D = -100mA |
| | | _ | 0.7 | 1.0 | | $V_{GS} = -4.5V, I_D = -100mA$ |
| Otatia Basis Oscara Os Basista as | _ | _ | 0.9 | 1.5 | Ω | $V_{GS} = -2.5V, I_D = -80mA$ |
| Static Drain-Source On-Resistance | R _{DS (ON)} | _ | 1.2 | 2.0 | | V _{GS} = -1.8V, I _D = -40mA |
| | | _ | 1.5 | 3.0 | | V _{GS} = -1.5V, I _D = -30mA |
| | | _ | 5 | _ | | V _{GS} = -1.2V, I _D = -1mA |
| Forward Transfer Admittance | Y _{fs} | _ | 0.7 | _ | S | $V_{DS} = -3V, I_{D} = -100 \text{mA}$ |
| Diode Forward Voltage | V _{SD} | _ | -0.75 | -1.2 | V | $V_{GS} = 0V, I_S = -330mA,$ |
| DYNAMIC CHARACTERISTICS (Note 7) | | | | | | • |
| Input Capacitance | Ciss | _ | 46.1 | l | | 101/11/ |
| Output Capacitance | Coss | _ | 7.2 | _ | pF | $V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz |
| Reverse Transfer Capacitance | C _{rss} | _ | 4.9 | 1 | | 1 - 1:01/11/12 |
| Gate Resistance | R_g | _ | 14.3 | | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, |
| Total Gate Charge V _{GS} = -4.5V | Qg | _ | 0.5 | l | | |
| Total Gate Charge V _{GS} = -10V | Q_g | _ | 0.85 | _ | nC | $V_{DS} = -10V, I_{D} = -250mA$ |
| Gate-Source Charge | Q _{gs} | _ | 0.09 | | 110 | |
| Gate-Drain Charge | Q_{gd} | _ | 0.09 | _ | | |
| Turn-On Delay Time | t _{D(on)} | _ | 8.5 | _ | | V - 2V V - 2.5V |
| Turn-On Rise Time | t _r | _ | 4.3 | _ | ns | $V_{DD} = -3V$, $V_{GS} = -2.5V$, |
| Turn-Off Delay Time | t _{D(off)} | _ | 20.2 | | 115 | $R_L = 300\Omega, R_G = 25\Omega,$ $I_D = -100 \text{mA}$ |
| Turn-Off Fall Time | t _f | _ | 19.2 | _ | | ID IOUIIA |

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



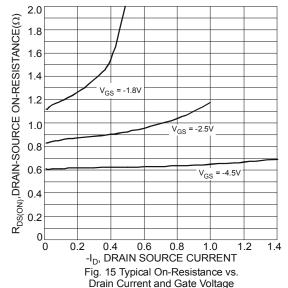


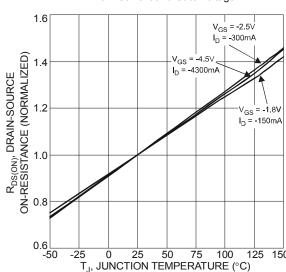
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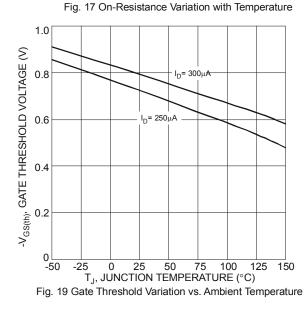
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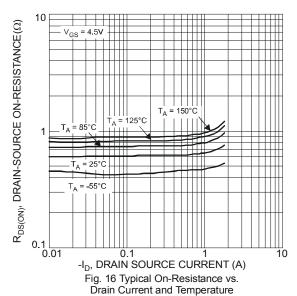
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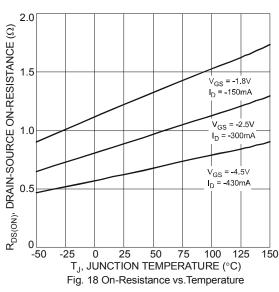
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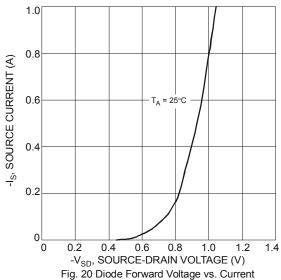






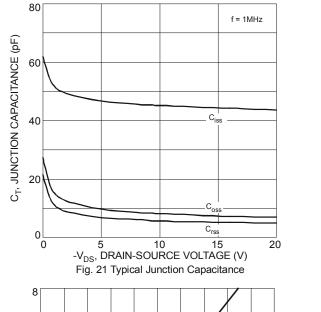


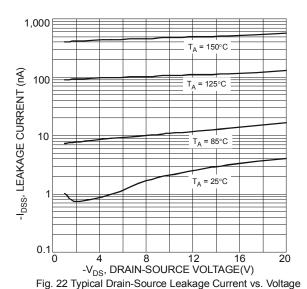




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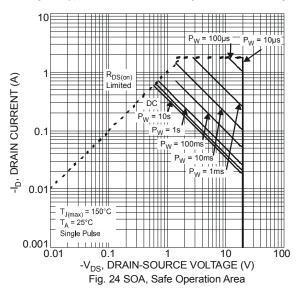
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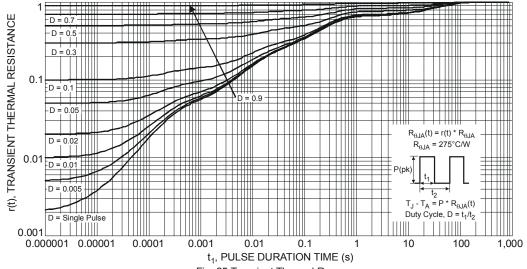




0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 Q_g, TOTAL GATE CHARGE (nC)

Fig. 23 Gate-Charge Characteristics





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Datasheet of DMC2400UV-7 - MOSFET N/P-CH 20V SOT563

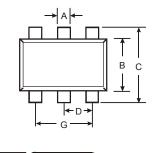
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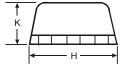


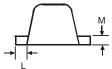
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Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



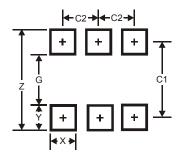




| | SOT563 | | | | | | |
|-------------------------|--------|---------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 0.15 | 0.30 | 0.20 | | | | |
| В | 1.10 | 1.25 | 1.20 | | | | |
| С | 1.55 | 1.70 | 1.60 | | | | |
| D | 1 | 1 | 0.50 | | | | |
| G | 0.90 | 1.10 | 1.00 | | | | |
| Н | 1.50 | 1.70 | 1.60 | | | | |
| K | 0.55 | 0.60 | 0.60 | | | | |
| L | 0.10 | 0.30 | 0.20 | | | | |
| M 0.10 0.18 0.17 | | | | | | | |
| All | Dimens | ions in | mm | | | | |

Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.2 |
| G | 1.2 |
| Х | 0.375 |
| Υ | 0.5 |
| C1 | 1.7 |
| C2 | 0.5 |



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DMC2400UV

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 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

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